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FAIRCHILD. FDMC8030	August 2016
Dual N-Channel Power Trench [®] MC 40 V, 12 A, 10 m Ω	OSFET
Features	General Description
 Max r_{DS(on)} = 10 mΩ at V_{GS} = 10 V, I_D = 12 A Max r_{DS(on)} = 14 mΩ at V_{GS} = 4.5 V, I_D = 10 A Max r_{DS(on)} = 28 mΩ at V_{GS} = 3.2 V, I_D = 4 A 	This device includes two 40V N-Channel MOSFETs in a dual Power 33 (3 mm X 3 mm MLP) package. The package is enhanced for exceptional thermal performance.
• Max $r_{DS(on)} = 20$ ms2 at $v_{GS} = 3.2$ v, $r_D = 4$ A • Termination is Lead-free and RoHS Compliant	 Applications Battery Protection Load Switching Point of Load
Pin 1 G1 S1 S1 S1 D1 D2 G2 S2 S2 S2 G2 S2 S2 S2 Power 33	$\begin{array}{c c} G2 \\ \hline \\ G2 \\ \hline \\ S2 \\ \hline \\ \\ S2 \\ \hline \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ $

MOSFET Maximum Ratings $T_A = 25 \text{ °C}$ unless otherwise noted.

Symbol	Parameter			Ratings	Units
V _{DS}	Drain to Source Voltage			40	V
V _{GS}	Gate to Source Voltage		(Note 4)	±12	V
ID	Drain Current -Continuous	T _A = 25 °C	(Note 1a)	12	٨
	-Pulsed			50	Α
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	21	mJ
P _D	Power Dissipation	T _C = 25 °C	T _C = 25 °C		14/
	Power Dissipation	T _A = 25 °C	(Note 1a)	1.9	W
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +150	°C

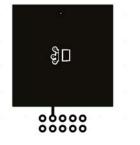
Thermal Characteristics

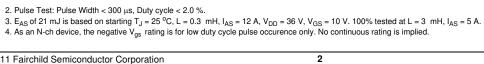
$R_{\theta JC}$	Thermal Resistance, Junction to Case	9.0	
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient (Note 1	a) 65	°C/W
R_{\thetaJA}	Thermal Resistance, Junction to Ambient (Note 1	o) 155	

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMC8030	FDMC8030	Power 33	13 "	12 mm	3000 units

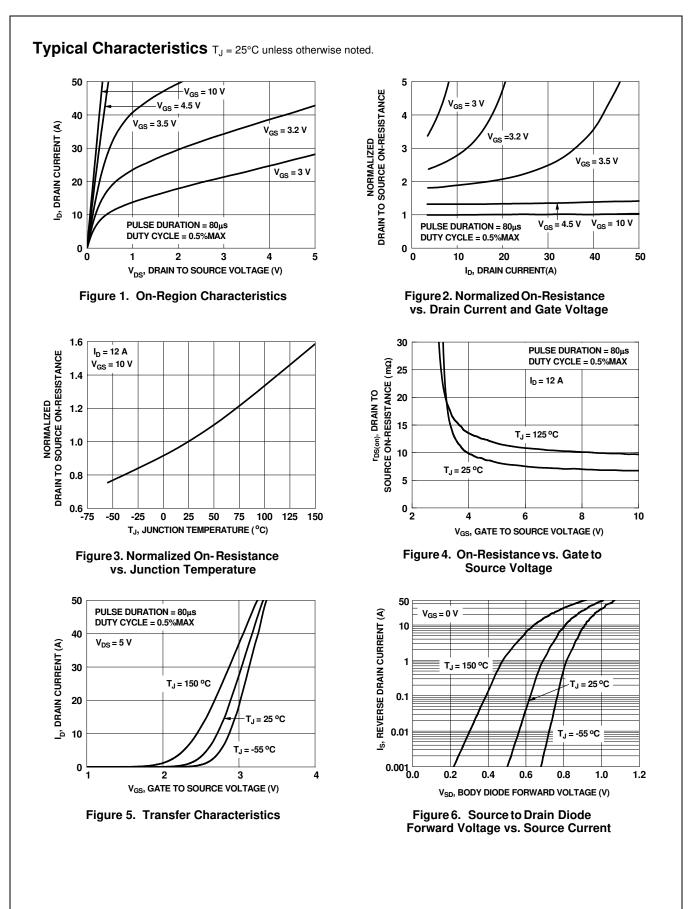
Symbol	Parameter	Test Conditions		Min.	Тур.	Max.	Units	
Off Chara	cteristics							
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 250 μA, V _{GS} = 0 V		40			V	
ΔBV_{DSS} ΔT_J	Breakdown Voltage Temperature	$I_D = 250 \ \mu$ A, referenced to	25 °C		19		mV/°C	
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 32 V, V _{GS} = 0 V				1	μA	
I _{GSS}	Gate to Source Leakage Current, Forward	$V_{GS} = 12 \text{ V}, V_{DS} = 0 \text{ V}$				100	nA	
On Chara	cteristics		· · · ·					
V _{GS(th)}	Gate to Source Threshold Voltage	V _{GS} = V _{DS} , I _D = 250 μA		1.0	1.5	2.8	V	
$\Delta V_{GS(th)}$ ΔT_{J}	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$, referenced to	25 °C		-5	2.0	mV/°C	
J		V _{GS} = 10 V, I _D = 12 A			8	10		
		$V_{GS} = 4.5 \text{ V}, I_D = 10 \text{ A}$			10	14	mΩ	
r _{DS(on)}	Static Drain to Source On Resistance	$V_{GS} = 3.2 \text{ V}, I_D = 4 \text{ A}$			19	28		
		$V_{GS} = 10 \text{ V}, I_D = 12 \text{ A}$ T _J = 125 °C			13	16		
9fs	Forward Transconductance	$V_{DD} = 5 V, I_D = 12 A$			57		S	
Dynamic	Characteristics							
C _{iss}	Input Capacitance	— V _{DS} = 20 V, V _{GS} = 0 V f = 1MHz			1462	1975	pF	
C _{oss}	Output Capacitance				321	430	pF	
C _{rss}	Reverse Transfer Capacitance				20	30	pF	
R _g	Gate Resistance				0.9	2.5	Ω	
Switching	g Characteristics							
t _{d(on)}	Turn-On Delay Time	V_{DD} = 20 V, I _D = 12 A V _{GS} = 10 V, R _{GEN} = 6 Ω			7	13	ns	
t _r	Rise Time				3	10	ns	
t _{d(off)}	Turn-Off Delay Time				19	33	ns	
t _f	Fall Time				3	10	ns	
0	Total Gate Charge	V _{GS} = 0 V to 10 V			21	30	nC	
Q _{g(TOT)}	Total Gate Charge	$V_{GS} = 0 V \text{ to } 5 V V_{DD} = 20 V$			12	17	nC	
Q _{gs}	Gate to Source Charge	I _D = 12	2 A		2.8		nC	
Q _{gd}	Gate to Drain "Miller" Charge				2.5		nC	
Drain-Sou	urce Diode Characteristics							
V _{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_{S} = 12 A$	(Note 2)		0.83	1.2	V	
t _{rr}	Reverse Recovery Time	- I _F = 12 A, di/dt = 100 A/μs			25	40	ns	
Q _{rr}	Reverse Recovery Charge				9	18	nC	
NOTES: I. R _{0JA} is determ the user's boa	ined with the device mounted on a 1 in ² pad 2 oz copper pac rd design.	on a 1.5 x 1.5 in. board of FR-4 mate	rial. R _{θJC} is gua	ranteed b	y design whil	e R _{θCA} is de	termined b	



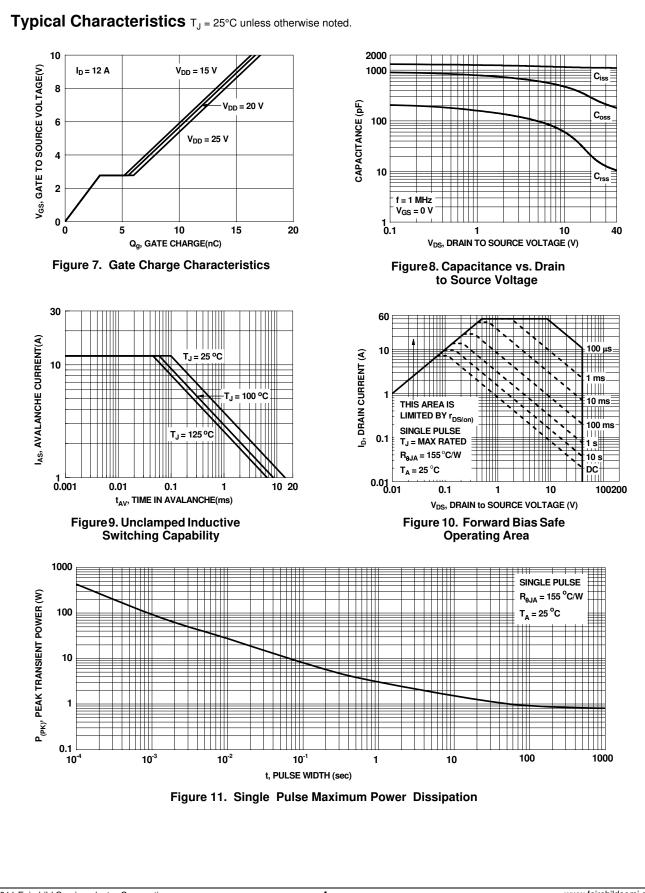


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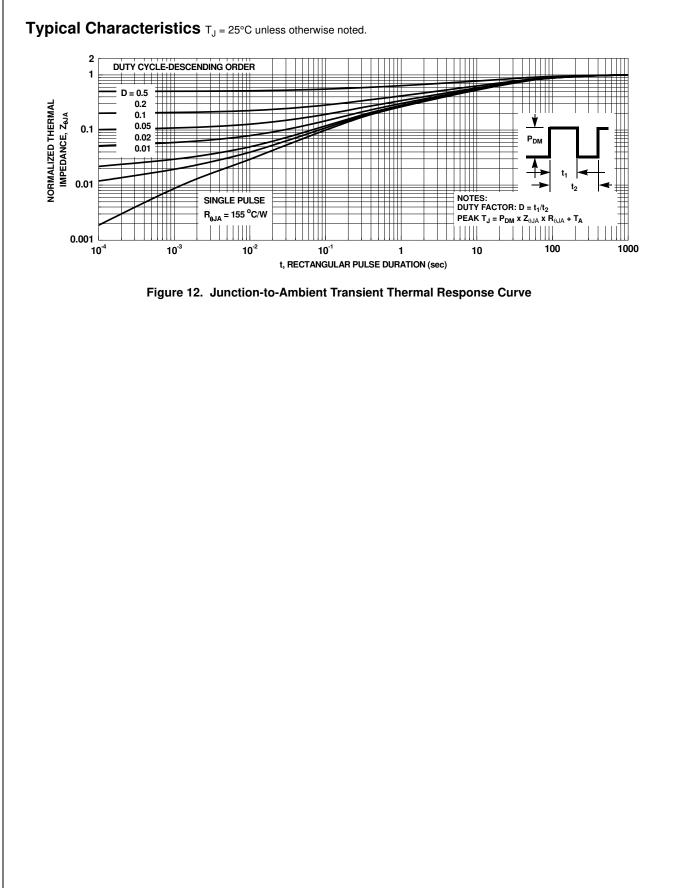
FDMC8030 Dual N-Channel Power Trench[®] MOSFET

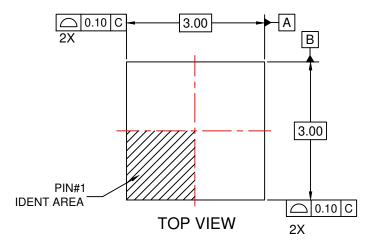


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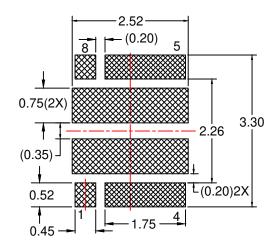
FDMC8030 Dual N-Channel Power Trench[®] MOSFET





0.80 MAX

// 0.10 C

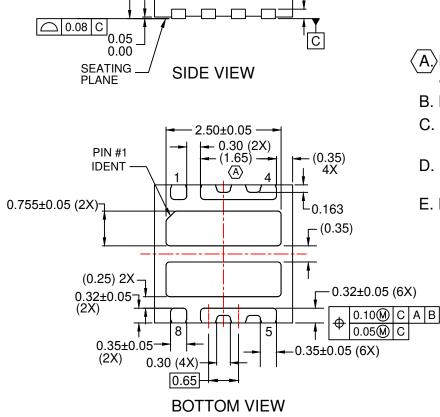


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- A DOES NOT FULLY CONFORM TO JEDEC REGISTRATION, MO-229.
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994
- D. LAND PATTERN RECOMMENDATION IS BASED ON FSC DESIGN ONLY
- E. DRAWING FILE NAME: MKT-MLP08Xrev2.



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